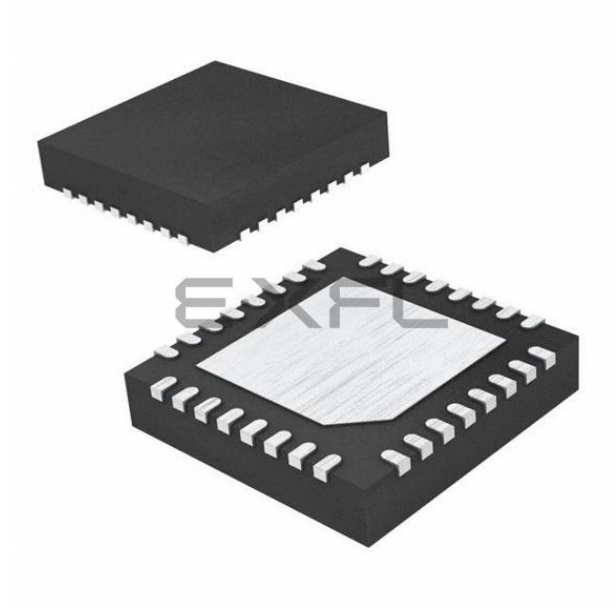
Microchip Technology - DSPIC33EP32GS202-E/MM Datasheet



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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

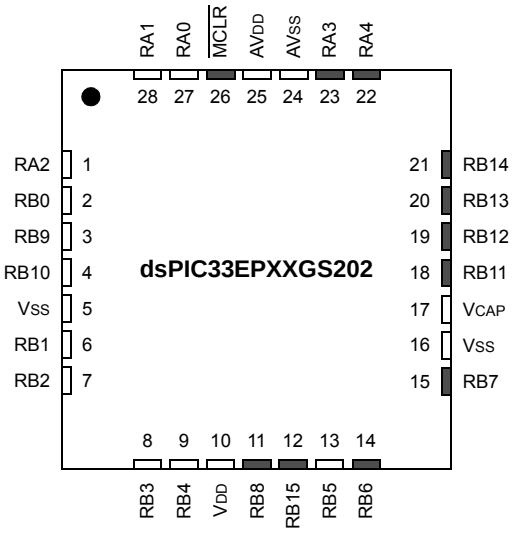
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	60 MIPs
Connectivity	I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	21
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 12x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN-S (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep32gs202-e-mm

Pin Diagrams (Continued)

28-Pin UQFN 4x4 mm, 28-Pin UQFN 6x6 mm, 28-Pin QFN-S 6x6 mm

■ = Pins are up to 5V tolerant



PIN FUNCTION DESCRIPTIONS

Pin	Pin Function	Pin	Pin Function
1	AN2/PGA1P3/PGA2P2/CMP1C/CMP2A/RA2	15	PGEC1/AN11/SDA1/**RP39**/RB7
2	AN3/PGA2P3/CMP1D/ CMP28/**RP32**/RB0	16	VSS
3	AN4/CMP2C/**RP41**/RB9	17	VCAP
4	AN5/CMP2D/**RP42**/RB10	18	TMS/PWM3H/**RP43**/RB11
5	VSS	19	TCK/PWM3L/**RP44**/RB12
6	OSC1/CLKI/AN6/**RP33**/RB1	20	PWM2H/**RP45**/RB13
7	OSC2/CLKO/AN7/PGA1N2/**RP34**/RB2	21	PWM2L/**RP46**/RB14
8	PGED2/AN8/INT0/**RP35**/RB3	22	PWM1H/RA4
9	PGEC2/ADTRG31/**RP36**/RB4	23	PWM1L/RA3
10	VDD	24	AVSS
11	PGED3/**RP40**/RB8	25	AVDD
12	PGEC3/**RP47**/RB15	26	$\overline{\text{MCLR}}$
13	TDO/AN9/PGA2N2/**RP37**/RB5	27	AN0/PGA1P1/CMP1A/RA0
14	PGED1/TDI/AN10/SCL1/**RP38**/RB6	28	AN1/PGA1P2/PGA2P1/CMP1B/RA1

Legend: Shaded pins are up to 5 VDC tolerant.

Note: **RPn** represents remappable peripheral functions. See Table 10-1 and Table 10-2 for the complete list of remappable sources.

1.0 DEVICE OVERVIEW

Note 1: This data sheet summarizes the features of the dsPIC33EPXXGS202 family of devices. It is not intended to be a comprehensive resource. To complement the information in this data sheet, refer to the related section in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

This document contains device-specific information for the dsPIC33EPXXGS202 Digital Signal Controller (DSC) devices.

The dsPIC33EPXXGS202 devices contain extensive Digital Signal Processor (DSP) functionality with a high-performance, 16-bit MCU architecture.

Figure 1-1 shows a general block diagram of the core and peripheral modules. Table 1-1 lists the functions of the various pins shown in the pinout diagrams.

FIGURE 1-1: dsPIC33EPXXGS202 FAMILY BLOCK DIAGRAM

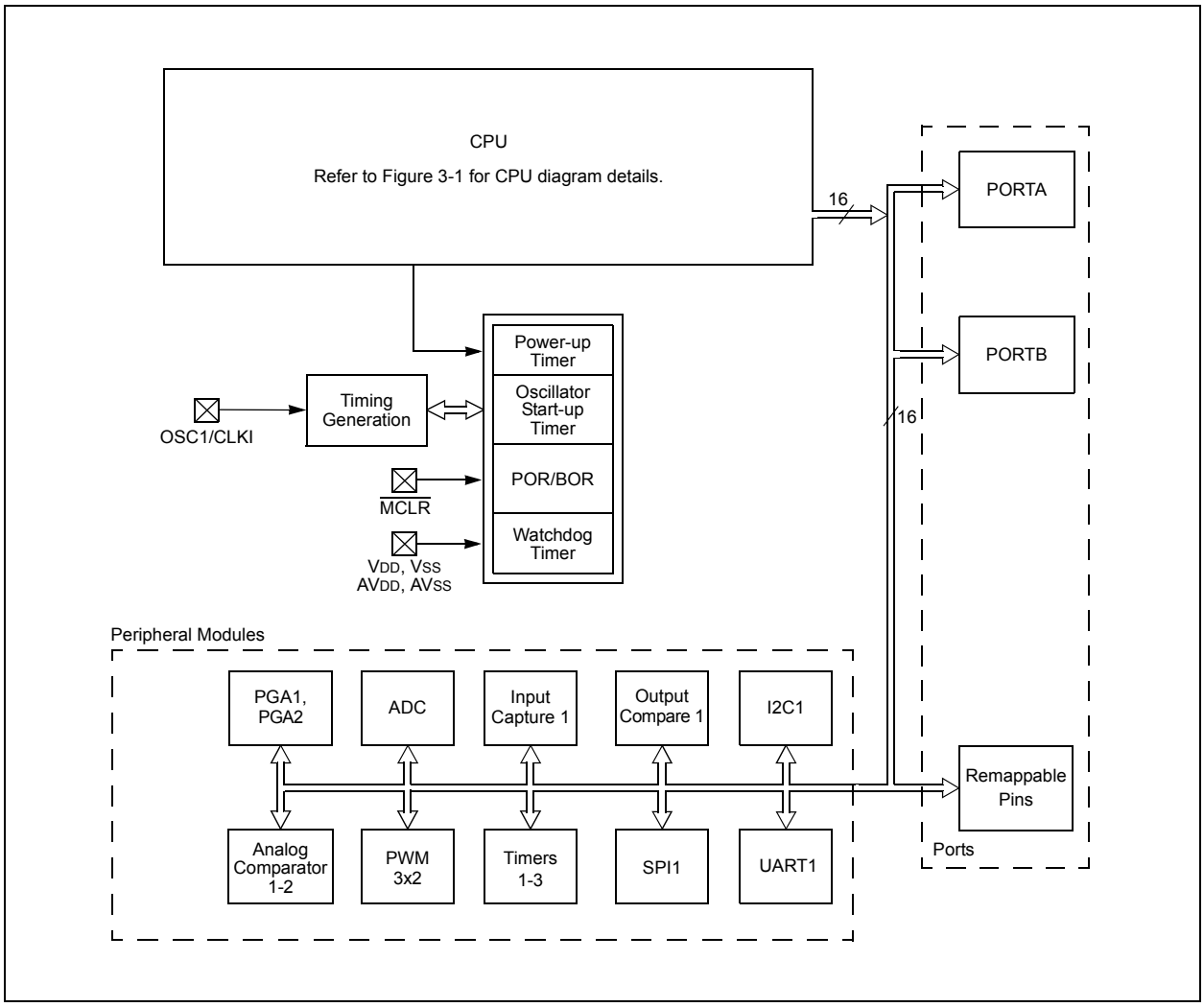


TABLE 7-1: INTERRUPT VECTOR DETAILS

Interrupt Source	Vector #	IRQ #	IVT Address	Interrupt Bit Location		
				Flag	Enable	Priority
Highest Natural Order Priority						
INT0 – External Interrupt 0	8	0	0x000014	IFS0<0>	IEC0<0>	IPC0<2:0>
IC1 – Input Capture 1	9	1	0x000016	IFS0<1>	IEC0<1>	IPC0<6:4>
OC1 – Output Compare 1	10	2	0x000018	IFS0<2>	IEC0<2>	IPC0<10:8>
T1 – Timer1	11	3	0x00001A	IFS0<3>	IEC0<3>	IPC0<14:12>
Reserved	12–14	4–6	0x00001C-0x000020	—	—	—
T2 – Timer2	15	7	0x000022	IFS0<7>	IEC0<7>	IPC1<14:12>
T3 – Timer3	16	8	0x000024	IFS0<8>	IEC0<8>	IPC2<2:0>
SPI1E – SPI1 Error	17	9	0x000026	IFS0<9>	IEC0<9>	IPC2<6:4>
SPI1 – SPI1 Transfer Done	18	10	0x000028	IFS0<10>	IEC0<10>	IPC2<10:8>
U1RX – UART1 Receiver	19	11	0x00002A	IFS0<11>	IEC0<11>	IPC2<14:12>
U1TX – UART1 Transmitter	20	12	0x00002C	IFS0<12>	IEC0<12>	IPC3<2:0>
ADC – ADC Global Convert Done	21	13	0x00002E	IFS0<13>	IEC0<13>	IPC3<6:4>
Reserved	22	14	0x000030	—	—	—
NVM – NVM Write Complete	23	15	0x000032	IFS0<15>	IEC0<15>	IPC3<14:12>
SI2C1 – I2C1 Slave Event	24	16	0x000034	IFS1<0>	IEC1<0>	IPC4<2:0>
MI2C1 – I2C1 Master Event	25	17	0x000036	IFS1<1>	IEC1<1>	IPC4<6:4>
CMP1 – Analog Comparator 1 Interrupt	26	18	0x000038	IFS1<2>	IEC1<2>	IPC4<10:8>
CN – Input Change Interrupt	27	19	0x00003A	IFS1<3>	IEC1<3>	IPC4<14:12>
INT1 – External Interrupt 1	28	20	0x00003C	IFS1<4>	IEC1<4>	IPC5<2:0>
Reserved	29-36	21-28	0x00003E-0x00004C	—	—	—
INT2 – External Interrupt 2	37	29	0x00004E	IFS1<13>	IEC1<13>	IPC7<6:4>
Reserved	38-64	30-56	0x000050-0x000084	—	—	—
PSEM – PWM Special Event Match	65	57	0x000086	IFS3<9>	IEC3<9>	IPC14<6:4>
Reserved	63-72	55-64	0x000088-0x000094	—	—	—
U1E – UART1 Error Interrupt	73	65	0x000096	IFS4<1>	IEC4<1>	IPC16<6:4>
Reserved	74-80	66-72	0x000098-0x0000A4	—	—	—
PWM Secondary Special Event Match	81	73	0x0000A6	IFS4<9>	IEC4<9>	IPC18<6:4>
Reserved	82-101	74-93	0x0000A8-0x0000CE	—	—	—
PWM1 – PWM1 Interrupt	102	94	0x0000D0	IFS5<14>	IEC5<14>	IPC23<10:8>
PWM2 – PWM2 Interrupt	103	95	0x0000D2	IFS5<15>	IEC5<15>	IPC23<14:12>
PWM3 – PWM3 Interrupt	104	96	0x0000D4	IFS6<0>	IEC6<0>	IPC24<2:0>
Reserved	105-110	97-102	0x0000D6-0x0000E0	—	—	—
CMP2 – Analog Comparator 2 Interrupt	111	103	0x0000E2	IFS6<7>	IEC6<7>	IPC25<14:12>
Reserved	112-117	104-109	0x0000E4-0x0000EE	—	—	—
AN0 Conversion Done	118	110	0x0000F0	IFS6<14>	IEC6<14>	IPC27<10:8>
AN1 Conversion Done	119	111	0x0000F2	IFS6<15>	IEC6<15>	IPC27<14:12>
AN2 Conversion Done	120	112	0x0000F4	IFS7<0>	IEC7<0>	IPC28<2:0>
AN3 Conversion Done	121	113	0x0000F6	IFS7<1>	IEC7<1>	IPC28<6:4>
AN4 Conversion Done	122	114	0x0000F8	IFS7<2>	IEC7<2>	IPC28<10:8>
AN5 Conversion Done	123	115	0x0000FA	IFS7<3>	IEC7<3>	IPC28<14:12>
AN6 Conversion Done	124	116	0x0000FC	IFS7<4>	IEC7<4>	IPC29<2:0>
AN7 Conversion Done	125	117	0x0000FE	IFS7<5>	IEC7<5>	IPC29<6:4>

REGISTER 10-18: RPOR2: PERIPHERAL PIN SELECT OUTPUT REGISTER 2

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP37R5	RP37R4	RP37R3	RP37R2	RP37R1	RP37R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP36R5	RP36R4	RP36R3	RP36R2	RP36R1	RP36R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **RP37R<5:0>:** Peripheral Output Function is Assigned to RP37 Output Pin bits (see Table 10-2 for peripheral function numbers)

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **RP36R<5:0>:** Peripheral Output Function is Assigned to RP36 Output Pin bits (see Table 10-2 for peripheral function numbers)

REGISTER 10-19: RPOR3: PERIPHERAL PIN SELECT OUTPUT REGISTER 3

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP39R5	RP39R4	RP39R3	RP39R2	RP39R1	RP39R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP38R5	RP38R4	RP38R3	RP38R2	RP38R1	RP38R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **RP39R<5:0>:** Peripheral Output Function is Assigned to RP39 Output Pin bits (see Table 10-2 for peripheral function numbers)

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **RP38R<5:0>:** Peripheral Output Function is Assigned to RP38 Output Pin bits (see Table 10-2 for peripheral function numbers)

NOTES:

12.0 TIMER2/3

Note 1: This data sheet summarizes the features of the dsPIC33EPXXGS202 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Timers"** (DS70362) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The Timer2/3 module is a 32-bit timer, which can also be configured as two independent 16-bit timers with selectable operating modes.

As 32-bit timers, Timer2 and Timer3 operate in three modes:

- Two Independent 16-Bit Timers (e.g., Timer2 and Timer3) with all 16-Bit Operating modes (except Asynchronous Counter mode)
- Single 32-Bit Timer
- Single 32-Bit Synchronous Counter

They also support these features:

- Timer Gate Operation
- Selectable Prescaler Settings
- Timer Operation during Idle and Sleep modes
- Interrupt on a 32-Bit Period Register Match
- Time Base for Input Capture and Output Compare modules (Timer2 and Timer3 only)

Individually, both of the 16-bit timers can function as synchronous timers or counters. They also offer the features listed previously, except for the event trigger; this is implemented only with Timer2/3. The operating modes and enabled features are determined by setting the appropriate bit(s) in the T2CON and T3CON registers. T2CON details are in Register 12-1. T3CON details are in Register 12-2.

For 32-bit timer/counter operation, Timer2 is the least significant word (lsw); Timer3 is the most significant word (msw) of the 32-bit timers.

Note: For 32-bit operation, T3CON control bits are ignored. Only T2CON control bits are used for setup and control. Timer2 clock and gate inputs are utilized for the 32-bit timer modules, but an interrupt is generated with the Timer3 interrupt flag.

A block diagram for an example 32-bit timer pair (Timer2/3) is shown in Figure 12-2.

12.1 Timer Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page contains the latest updates and additional information.

12.1.1 KEY RESOURCES

- **"Timers"** (DS70362) in the *"dsPIC33/PIC24 Family Reference Manual"*
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related *"dsPIC33/PIC24 Family Reference Manual"* Sections
- Development Tools

REGISTER 15-8: SSEVTCMP: PWM SECONDARY SPECIAL EVENT COMPARE REGISTER(1)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SSEVTCMP<12:5>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
SSEVTCMP<4:0>					—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-3 **SSEVTCMP<12:0>:** Special Event Compare Count Value bits

bit 2-0 **Unimplemented:** Read as '0'

Note 1: One LSB = 1.04 ns (at fastest auxiliary clock rate); therefore, the minimum SEVTCMP resolution is 8.32 ns.

REGISTER 15-9: CHOP: PWM CHOP CLOCK GENERATOR REGISTER(1)

R/W-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
CHPCLKEN	—	—	—	—	—	CHOPCLK6	CHOPCLK5
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
CHOPCLK4	CHOPCLK3	CHOPCLK2	CHOPCLK1	CHOPCLK0	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **CHPCLKEN:** Enable Chop Clock Generator bit

1 = Chop clock generator is enabled
0 = Chop clock generator is disabled

bit 14-10 **Unimplemented:** Read as '0'

bit 9-3 **CHOPCLK<6:0>:** Chop Clock Divider bits

Value is in 8.32 ns increments. The frequency of the chop clock signal is given by the following expression:

*Chop Frequency = 1/(16.64 * (CHOPCLK<6:0> + 1) * Primary Master PWM Input Clock Period)*

bit 2-0 **Unimplemented:** Read as '0'

Note 1: The chop clock generator operates with the primary PWM clock prescaler (PCLKDIV<2:0>) in the PTCON2 register (Register 15-2).

REGISTER 15-10: MDC: PWM MASTER DUTY CYCLE REGISTER(1,2)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
MDC<15:8>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
MDC<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **MDC<15:0>:** Master PWM Duty Cycle Value bits

Note 1: The smallest pulse width that can be generated on the PWMx output corresponds to a value of 0x0008, while the maximum pulse width generated corresponds to a value of Period – 0x0008.

2: As the duty cycle gets closer to 0% or 100% of the PWM period (0 to 40 ns, depending on the mode of operation), PWM duty cycle resolution will increase from 1 to 3 LSBs.

REGISTER 15-11: PWMKEY: PWM PROTECTION LOCK/UNLOCK KEY REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PWMKEY<15:8>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PWMKEY<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **PWMKEY<15:0>:** PWM Protection Lock/Unlock Key Value bits

REGISTER 15-24: LEBCONx: PWMx LEADING-EDGE BLANKING (LEB) CONTROL REGISTER (CONTINUED)

bit 1 **BPLH:** Blanking in PWMxL High Enable bit
1 = State blanking (of current-limit and/or Fault input signals) when the PWMxL output is high
0 = No blanking when the PWMxL output is high

bit 0 **BPLL:** Blanking in PWMxL Low Enable bit
1 = State blanking (of current-limit and/or Fault input signals) when the PWMxL output is low
0 = No blanking when the PWMxL output is low

Note 1: The blanking signal is selected via the BLANKSEL<3:0> bits in the AUXCONx register.

REGISTER 15-25: LEBDLYx: PWMx LEADING-EDGE BLANKING DELAY REGISTER

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	—	LEB<8:5>			
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
LEB<4:0>					—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-12 **Unimplemented:** Read as ‘0’

bit 11-3 **LEB<8:0>:** Leading-Edge Blanking Delay for Current-Limit and Fault Inputs bits
The value is in 8.32 ns increments.

bit 2-0 **Unimplemented:** Read as ‘0’

REGISTER 19-11: ADCOREXL: DEDICATED ADC CORE x CONTROL REGISTER LOW (x = 0,1)

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
—	—	—	—	—	—	SAMC<9:8>	
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SAMC<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-10 **Unimplemented:** Read as '0'

bit 9-0 **SAMC<9:0>:** Dedicated ADC Core x Conversion Delay Selection bits

These bits determine the time between the trigger event and the start of conversion in the number of the ADC Core Clock (TADCORE) periods. During this time, the ADC Core x still continues sampling. This feature is enabled by the SAMCxEN bit in the ADCON4L register.

1111111111 = 1025 TADCORE

•

•

•

0000000001 = 3 TADCORE

0000000000 = 2 TADCORE

REGISTER 19-26: ADFL0CON: ADC DIGITAL FILTER 0 CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0, HC, HS
FLEN	MODE1	MODE0	OVRSAM2	OVRSAM1	OVRSAM0	IE	RDY
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	FLCHSEL4	FLCHSEL3	FLCHSEL2	FLCHSEL1	FLCHSEL0
bit 7							bit 0

Legend:	HC = Hardware Clearable bit	HS = Hardware Settable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **FLEN:** Filter Enable bit
1 = Filter is enabled
0 = Filter is disabled and the RDY bit is cleared

bit 14-13 **MODE<1:0>:** Filter Mode bits
11 = Averaging mode
10 = Reserved
01 = Reserved
00 = Oversampling mode

bit 12-10 **OVRSAM<2:0>:** Filter Averaging/Oversampling Ratio bits
If MODE<1:0> = 00:
111 = 128x (16-bit result in the ADFL0DAT register is in 12.4 format)
110 = 32x (15-bit result in the ADFL0DAT register is in 12.3 format)
101 = 8x (14-bit result in the ADFL0DAT register is in 12.2 format)
100 = 2x (13-bit result in the ADFL0DAT register is in 12.1 format)
011 = 256x (16-bit result in the ADFL0DAT register is in 12.4 format)
010 = 64x (15-bit result in the ADFL0DAT register is in 12.3 format)
001 = 16x (14-bit result in the ADFL0DAT register is in 12.2 format)
000 = 4x (13-bit result in the ADFL0DAT register is in 12.1 format)
If MODE<1:0> = 11 (12-bit result in the ADFL0DAT register):
111 = 256x
110 = 128x
101 = 64x
100 = 32x
011 = 16x
010 = 8x
001 = 4x
000 = 2x

bit 9 **IE:** Filter Common ADC Interrupt Enable bit
1 = Common ADC interrupt will be generated when the filter result will be ready
0 = Common ADC interrupt will not be generated for the filter

bit 8 **RDY:** Oversampling Filter Data Ready Flag bit
This bit is cleared by hardware when the result is read from the ADFL0DAT register.
1 = Data in the ADFL0DAT register is ready
0 = The ADFL0DAT register has been read and new data in the ADFL0DAT register is not ready

bit 7-5 **Unimplemented:** Read as '0'

REGISTER 21-1: PGAxCON: PGAx CONTROL REGISTER (x = 1,2) (CONTINUED)

bit 2-0 **GAIN<2:0>:** PGAx Gain Selection bits
111 = Reserved
110 = Gain of 64
101 = Gain of 32
100 = Gain of 16
011 = Gain of 8
010 = Gain of 4
001 = Reserved
000 = Reserved

REGISTER 21-2: PGAxCAL: PGAx CALIBRATION REGISTER (x = 1,2)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	PGACAL<5:0>					
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-6 **Unimplemented:** Read as '0'

bit 5-0 **PGACAL<5:0>:** PGAx Offset Calibration bits
The calibration values for PGA1 and PGA2 must be copied from Flash addresses, 0x800E48 and 0x800E4C, respectively, into these bits before the module is enabled. Refer to the Device Calibration Addresses table (Table 22-3) in **Section 22.0 "Special Features"** for more information.

22.6 Watchdog Timer (WDT)

For dsPIC33EPXXGS202 family devices, the WDT is driven by the LPRC oscillator. When the WDT is enabled, the clock source is also enabled.

22.6.1 PRESCALER/POSTSCALER

The nominal WDT clock source from LPRC is 32 kHz. This feeds a prescaler that can be configured for either 5-bit (divide-by-32) or 7-bit (divide-by-128) operation. The prescaler is set by the WDTPRE Configuration bit. With a 32 kHz input, the prescaler yields a WDT Time-out Period (TWDT), as shown in Parameter SY12 in Table 25-23.

A variable postscaler divides down the WDT prescaler output and allows for a wide range of time-out periods. The postscaler is controlled by the WDTPOST<3:0> Configuration bits (FWDT<3:0>), which allow the selection of 16 settings, from 1:1 to 1:32,768. Using the prescaler and postscaler, time-out periods, ranges from 1 ms to 131 seconds can be achieved.

The WDT, prescaler and postscaler are reset:

- On any device Reset
- On the completion of a clock switch, whether invoked by software (i.e., setting the OSWEN bit after changing the NOSCx bits) or by hardware (i.e., Fail-Safe Clock Monitor)
- When a PWRSAV instruction is executed (i.e., Sleep or Idle mode is entered)
- When the device exits Sleep or Idle mode to resume normal operation
- By a CLRWDT instruction during normal execution

Note: The CLRWDT and PWRSAV instructions clear the prescaler and postscaler counts when executed.

22.6.2 SLEEP AND IDLE MODES

If the WDT is enabled, it continues to run during Sleep or Idle modes. When the WDT time-out occurs, the device wakes and code execution continues from where the PWRSAV instruction was executed. The corresponding SLEEP or IDLE bit (RCON<3:2>) needs to be cleared in software after the device wakes up.

22.6.3 ENABLING WDT

The WDT is enabled or disabled by the WDTEN<1:0> Configuration bits in the FWDT Configuration register. When the WDTEN<1:0> Configuration bits have been programmed to '0b11', the WDT is always enabled.

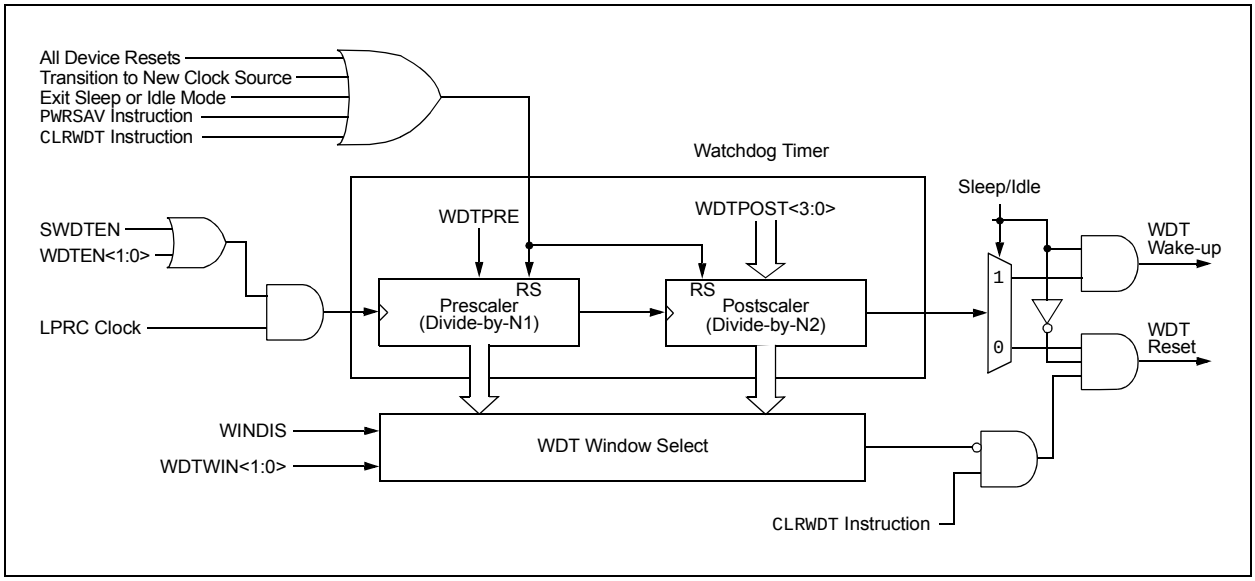
The WDT can be optionally controlled in software when the WDTEN<1:0> Configuration bits have been programmed to '0b10'. The WDT is enabled in software by setting the SWDTEN control bit (RCON<5>). The SWDTEN control bit is cleared on any device Reset. The software WDT option allows the user application to enable the WDT for critical Code Segments and disables the WDT during non-critical segments for maximum power savings.

The WDT Time-out flag bit, WDTO (RCON<4>), is not automatically cleared following a WDT time-out. To detect subsequent WDT events, the flag must be cleared in software.

22.6.4 WDT WINDOW

The Watchdog Timer has an optional Windowed mode, enabled by programming the WINDIS bit in the WDT Configuration register (FWDT<7>). In the Windowed mode (WINDIS = 0), the WDT should be cleared based on the settings in the programmable Watchdog Timer Window select bits (WDTWIN<1:0>).

FIGURE 22-2: WDT BLOCK DIAGRAM



24.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16 and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

24.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB X IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

24.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

24.5 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

TABLE 25-7: DC CHARACTERISTICS: IDLE CURRENT (IIDLE)

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Parameter No.	**Typ.**	**Max.**	**Units**	**Conditions**		
Idle Current (IIDLE)(1)						
DC40d	1	3	mA	-40°C	3.3V	10 MIPS
DC40a	1	3	mA	+25°C		
DC40b	1	3	mA	+85°C		
DC40c	1	3	mA	+125°C		
DC42d	3	5	mA	-40°C	3.3V	20 MIPS
DC42a	3	5	mA	+25°C		
DC42b	3	5	mA	+85°C		
DC42c	3	5	mA	+125°C		
DC44d	5	7	mA	-40°C	3.3V	40 MIPS
DC44a	5	7	mA	+25°C		
DC44b	5	7	mA	+85°C		
DC44c	5	7	mA	+125°C		
DC45d	7	9	mA	-40°C	3.3V	60 MIPS
DC45a	7	9	mA	+25°C		
DC45b	7	9	mA	+85°C		
DC45c	7	9	mA	+125°C		
DC46d	9	12	mA	-40°C	3.3V	70 MIPS
DC46a	9	12	mA	+25°C		
DC46b	9	12	mA	+85°C		

Note 1: Base Idle current (IIDLE) is measured as follows:

- CPU core is off, oscillator is configured in EC mode and external clock is active; OSC1 is driven with external square wave from rail-to-rail (EC Clock Overshoot/Undershoot < 250 mV required)
- CLKO is configured as an I/O input pin in the Configuration Word
- All I/O pins are configured as outputs and driving low
- $\overline{MCLR}$ = VDD, WDT and FSCM are disabled
- No peripheral modules are operating or being clocked (defined PMDx bits are all ones)
- The NVMSIDL bit (NVMCON<12>) = 1 (i.e., Flash regulator is set to standby while the device is in Idle mode)
- The VREGSF bit (RCON<11>) = 0 (i.e., Flash regulator is set to standby while the device is in Sleep mode)
- JTAG is disabled

TABLE 25-23: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min.**	**Typ.(2)**	**Max.**	**Units**	**Conditions**
SY00	TPU	Power-up Period	—	400	600	μs	
SY10	TOST	Oscillator Start-up Time	—	1024 TOSC	—	—	TOSC = OSC1 Period
SY12	TWDT	Watchdog Timer Time-out Period	0.81	—	1.22	ms	WDTPRE = 0, WDTPOST<3:0> = 0000, using LPRC tolerances indicated in F21a/F21b (see Table 25-21) at +85°C
			3.25	—	4.88	ms	WDTPRE = 1, WDTPOST<3:0> = 0000, using LPRC tolerances indicated in F21a/F21b (see Table 25-21) at +85°C
SY13	TIOZ	I/O High-Impedance from $\overline{\text{MCLR}}$ Low or Watchdog Timer Reset	0.68	0.72	1.2	μs	
SY20	TMCLR	$\overline{\text{MCLR}}$ Pulse Width (low)	2	—	—	μs	
SY30	TBOR	BOR Pulse Width (low)	1	—	—	μs	
SY35	TFSCM	Fail-Safe Clock Monitor Delay	—	500	900	μs	-40°C to +85°C
SY36	TVREG	Voltage Regulator Standby-to-Active mode Transition Time	—	—	30	μs	
SY37	TOSCDFRC	FRC Oscillator Start-up Delay	—	—	29	μs	
SY38	TOSCDLPRC	LPRC Oscillator Start-up Delay	—	—	70	μs	

Note 1: These parameters are characterized but not tested in manufacturing.

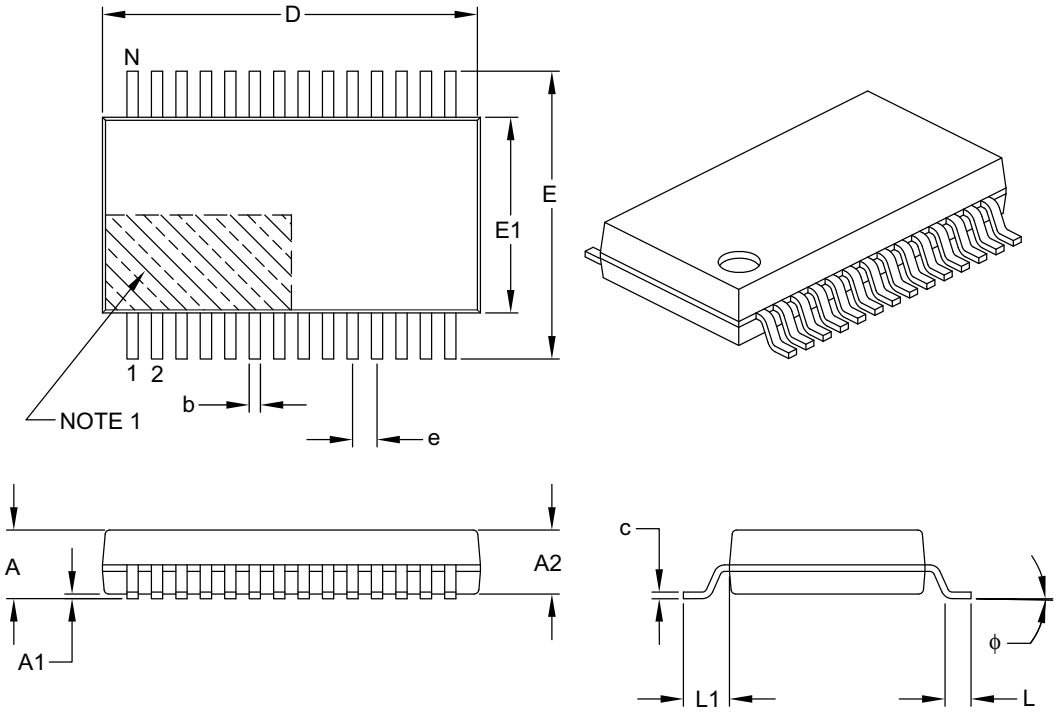
2: Data in "Typ." column is at 3.3V, +25°C unless otherwise stated.

NOTES:

27.2 Package Details

28-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		0.65 BSC	
Overall Height	A	–	–	2.00
Molded Package Thickness	A2	1.65	1.75	1.85
Standoff	A1	0.05	–	–
Overall Width	E	7.40	7.80	8.20
Molded Package Width	E1	5.00	5.30	5.60
Overall Length	D	9.90	10.20	10.50
Foot Length	L	0.55	0.75	0.95
Footprint	L1		1.25 REF	
Lead Thickness	c	0.09	–	0.25
Foot Angle	ϕ	0°	4°	8°
Lead Width	b	0.22	–	0.38

Notes:

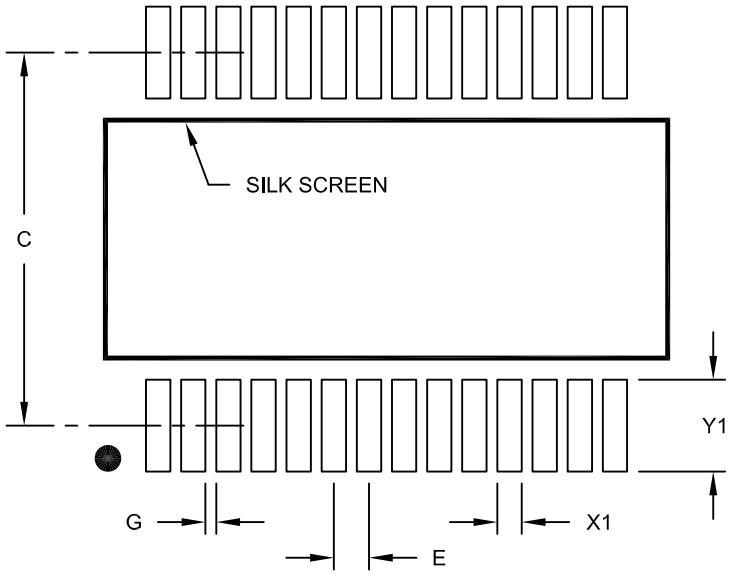
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B

28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Contact Pad Spacing	C		7.20	
Contact Pad Width (X28)	X1			0.45
Contact Pad Length (X28)	Y1			1.75
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2073A

NOTES: